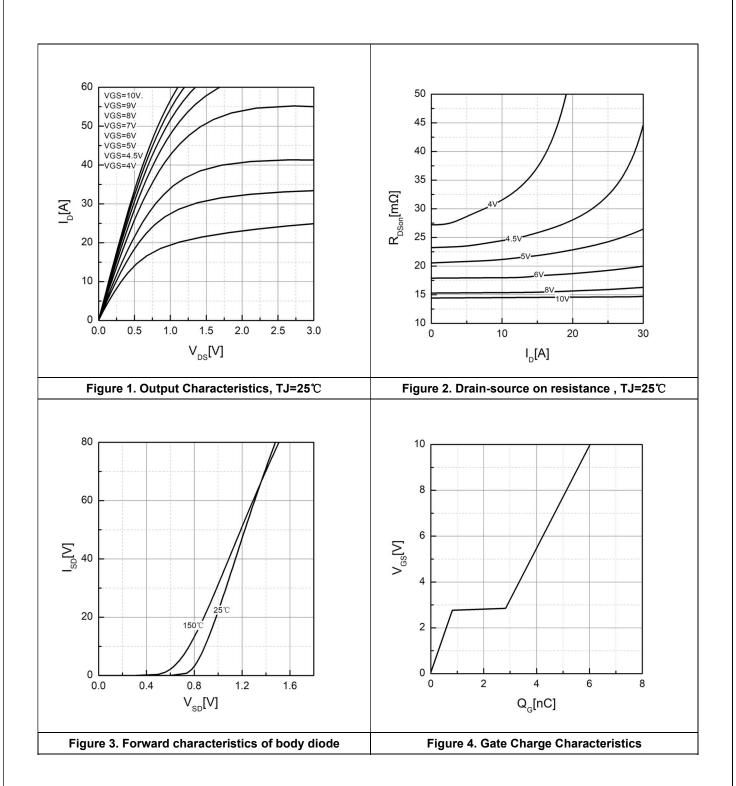
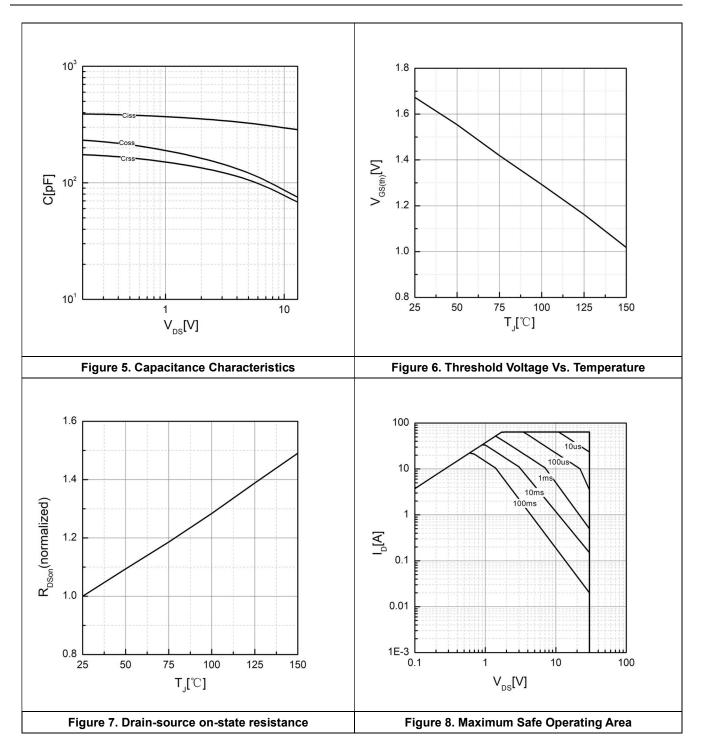


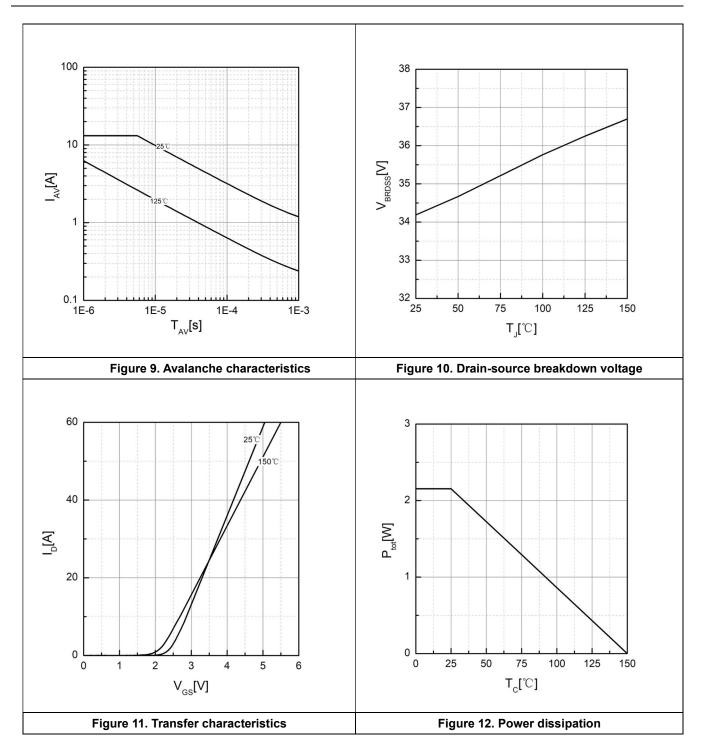
#### **Typical Performance Characteristics**



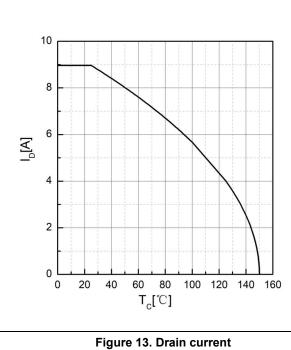












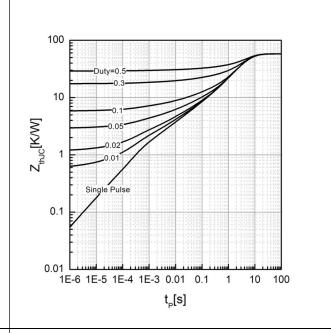
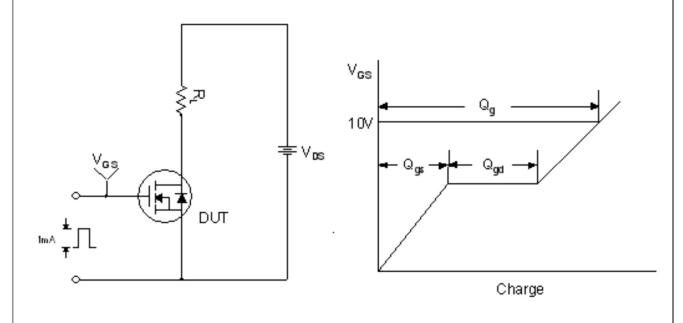


Figure 14. Effective Transient Thermal Impedance





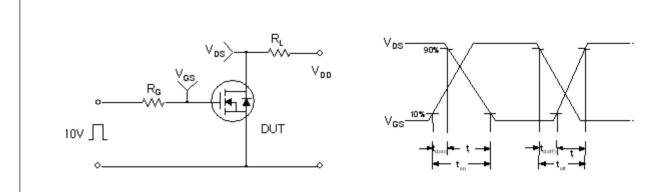
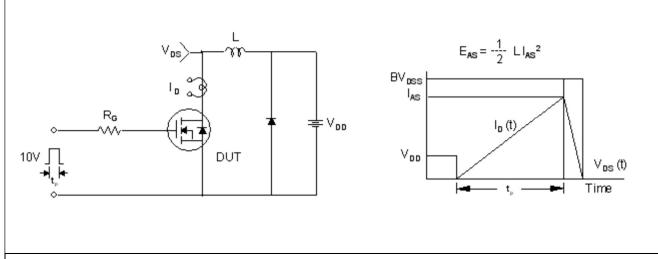
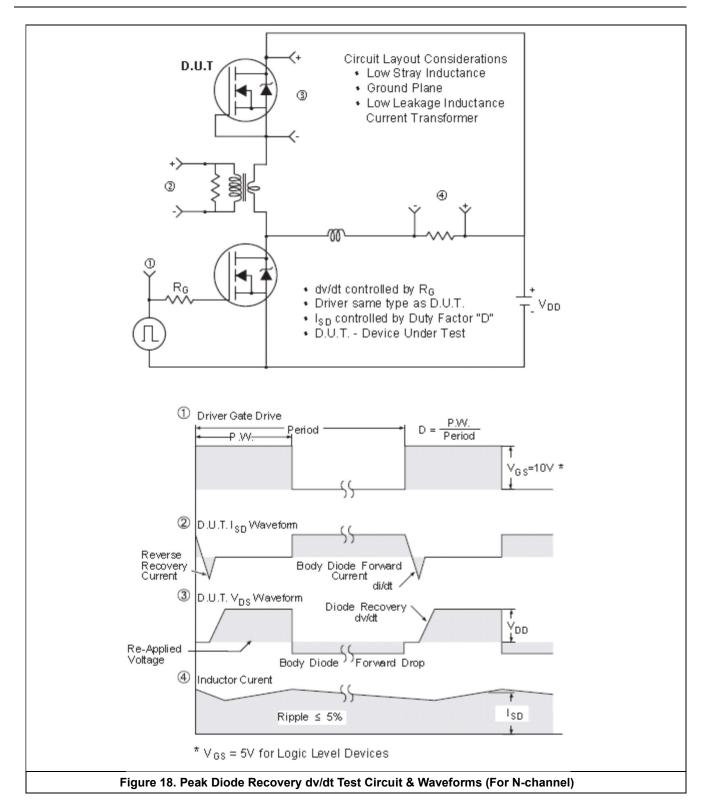


Figure 16. Resistive Switching Test Circuit & Waveforms

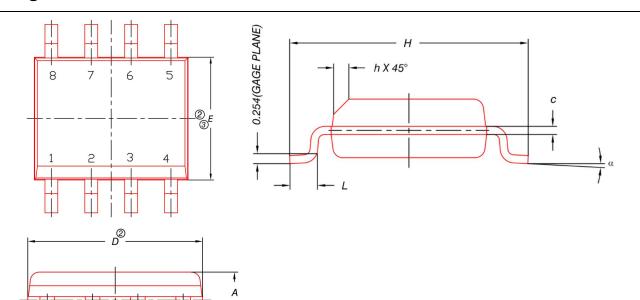








#### Package outline

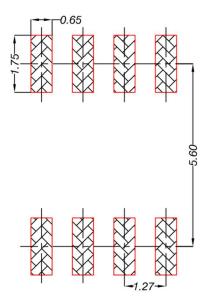


0.10

A(1)

DIM.	MILLIMETERS		
	MIN.	NOM.	MAX.
Α	1.35	1.55	1.75
A(1)	0.10	0.18	0.25
В	0.38	0.45	0.51
С	0.19	0.22	0.25
D	4.80	4.90	5.00
Ε	3.80	3.90	4.00
е	1.27 BSC		
Н	5.80	6.00	6.20
L	0.50	0.72	0.93
α	<i>0</i> °	4°	8°
h	0.25	0.38	0.50

Land Pattern
(Only for Reference)



#### Note:

- 1. All Dimension Are In mm.
- 2 Package Body Sizes Exclude Mold Flash, Protrusion Or Gate Burrs. Mold Flash, Protrusion Or Gate Burrs Shall Not Exceed 0.10 mm Per Side.
- 3 Package Body Sizes Determined At The Outermost Extremes Of The Plastic Body Exclusive Of Mold Flash, Tie Bar Burrs, Gate Burrs And Interlead Flash, But Including Any Mismatch Between The Top And Bottom Of The Plastic Body.
- 4. The Package Top May Be Smaller Than The Package Bottom.
- Dimension "B" Does Not Include Dambar Protrusion. Allowable Dambar Protrusion Shall Be 0.08 mm Total In Excess Of "B" Dimension At Maximum Material Condition. The Dambar Cannot Be Located On The Lower Radius Of The Foot.

Figure 19. SOP8 Package outline



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